

# SN54ABT657A, SN74ABT657A OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

SCBS192E – JANUARY 1991 – REVISED JUNE 1997

- State-of-the-Art **EPIC-II<sup>B</sup>**™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA  $I_{OH}$ , 64-mA  $I_{OL}$ )
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Plastic (NT) and Ceramic (JT) DIPs

## description

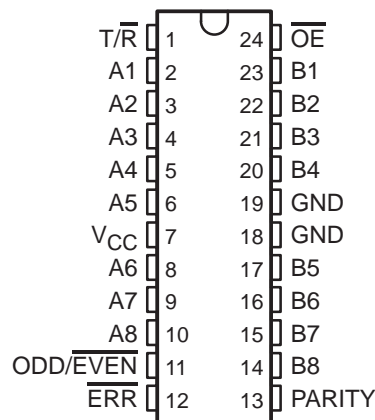
The 'ABT657A transceivers have eight noninverting buffers with parity-generator/checker circuits and control signals. The transmit/receive ( $T/\bar{R}$ ) input determines the direction of data flow. When  $T/\bar{R}$  is high, data flows from the A port to the B port (transmit mode); when  $T/\bar{R}$  is low, data flows from the B port to the A port (receive mode). When the output-enable ( $\overline{OE}$ ) input is high, both the A and B ports are in the high-impedance state.

Odd or even parity is selected by a logic high or low level on the  $ODD/\overline{EVEN}$  input.  $PARITY$  carries the parity-bit value; it is an output from the parity generator/checker in the transmit mode and an input to the parity generator/checker in the receive mode.

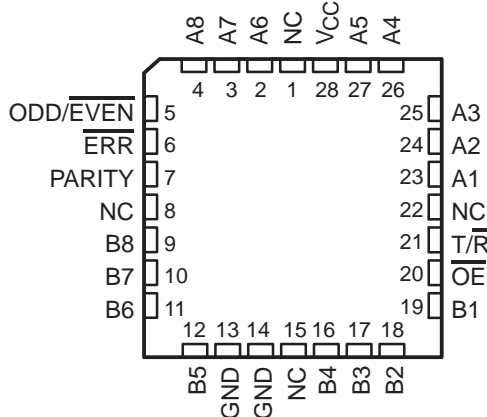
In the transmit mode, after the A bus is polled to determine the number of high bits,  $PARITY$  is set to the logic level that maintains the parity sense selected by the level at  $ODD/\overline{EVEN}$ . For example, if  $ODD/\overline{EVEN}$  is low (even parity selected) and there are five high bits on the A bus,  $PARITY$  is set to the logic high level so that an even number of the nine total bits (eight A-bus bits plus parity bit) are high.

In the receive mode, after the B bus is polled to determine the number of high bits, the error ( $\overline{ERR}$ ) output logic level indicates whether or not the data to be received exhibits the correct parity sense. For example, if  $ODD/\overline{EVEN}$  is high (odd parity selected),  $PARITY$  is high, and there are three high bits on the B bus,  $\overline{ERR}$  is low, indicating a parity error.

SN54ABT657A ... JT PACKAGE  
SN74ABT657A ... DW OR NT PACKAGE  
(TOP VIEW)



SN54ABT657A ... FK PACKAGE  
(TOP VIEW)



NC – No internal connection



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INSTRUMENTS**

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# SN54ABT657A, SN74ABT657A

## OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS

### AND 3-STATE OUTPUTS

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#### description (continued)

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT657A is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74ABT657A is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

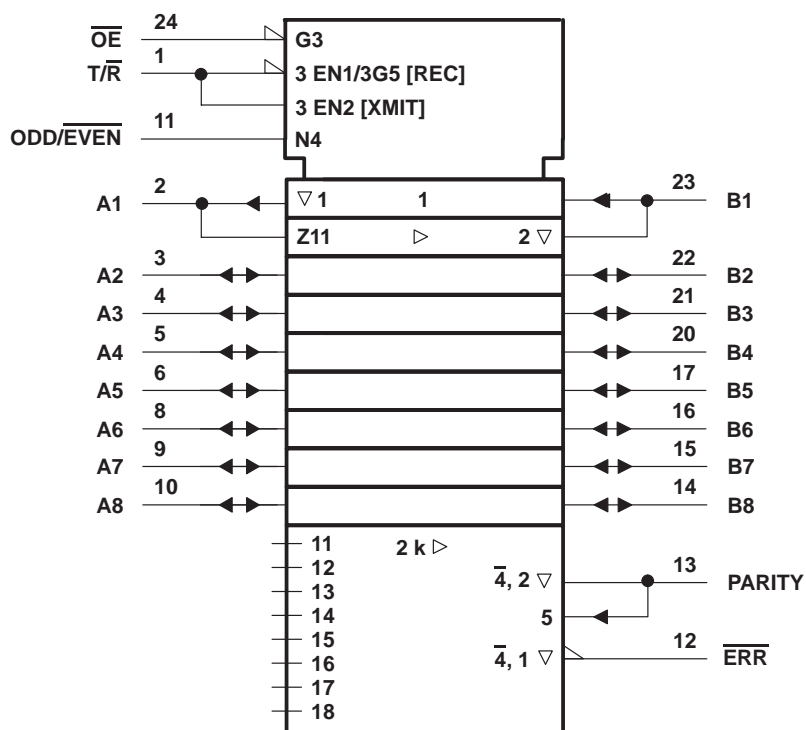
FUNCTION TABLE

NUMBER OF A OR B INPUTS THAT ARE HIGH	INPUTS			I/O PARITY	OUTPUTS	
	$\overline{OE}$	$\overline{T/R}$	ODD/ $\overline{EVEN}$		$\overline{ERR}$	OUTPUT MODE
0, 2, 4, 6, 8	L	H	H	H	Z	Transmit
	L	H	L	L	Z	Transmit
	L	L	H	H	H	Receive
	L	L	H	L	L	Receive
	L	L	L	H	L	Receive
	L	L	L	L	H	Receive
1, 3, 5, 7	L	H	H	L	Z	Transmit
	L	H	L	H	Z	Transmit
	L	L	H	H	L	Receive
	L	L	H	L	H	Receive
	L	L	L	H	H	Receive
	L	L	L	L	L	Receive
Don't care	H	X	X	Z	Z	Z

# SN54ABT657A, SN74ABT657A OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

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logic symbol†

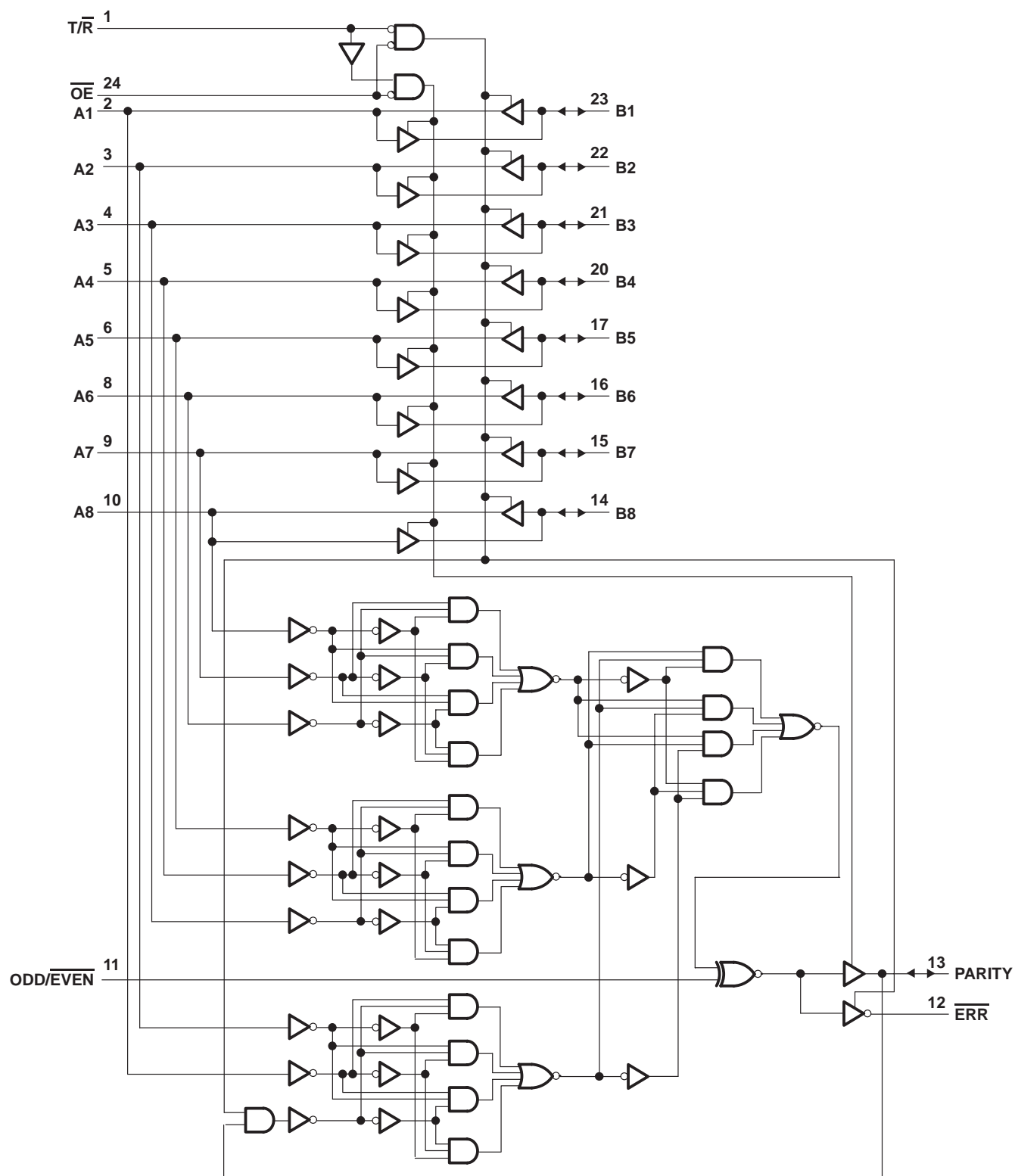


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for the DW, JT, and NT packages.

# SN54ABT657A, SN74ABT657A OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

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## logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

# SN54ABT657A, SN74ABT657A OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT657A	96 mA
SN74ABT657A	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package	81°C/W
NT package	67°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

## recommended operating conditions (see Note 3)

		SN54ABT657A		SN74ABT657A		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			5	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μs/V
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

# SN54ABT657A, SN74ABT657A

## OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T <sub>A</sub> = 25°C			SN54ABT657A		SN74ABT657A		UNIT	
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX		
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA	-1.2			-1.2		-1.2		V	
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA	2.5			2.5		2.5		V	
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA	3			3		3			
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2				
			I <sub>OH</sub> = -32 mA	2*					2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA	0.55			0.55		V		
			I <sub>OL</sub> = 64 mA	0.55*			0.55				
V <sub>hys</sub>			100							mV	
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 0 to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND	±1			±1		±1		μA	
	A or B ports	V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND	±20			±20		±20			
I <sub>OZPU</sub> ‡		V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{\text{OE}}$ = X	±50			±50		±50		μA	
I <sub>OZPD</sub> ‡		V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{\text{OE}}$ = X	±50			±50		±50		μA	
I <sub>OZH</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 2.7 V, $\overline{\text{OE}}$ ≥ 2 V	10			10		10		μA	
I <sub>OZL</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 0.5 V, $\overline{\text{OE}}$ ≥ 2 V	-10			-10		-10		μA	
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V	±100					±100		μA	
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	50			50		50		μA	
I <sub>O</sub> ¶		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V	-50	-100	-200	-50	-200	-50	-200	mA	
I <sub>CC</sub>		V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high		250		250		250		μA
			Outputs low		40		40		40		mA
			Outputs disabled		250		250		250		μA
ΔI <sub>CC</sub> #	Data inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	Outputs enabled		1.5		1.5		1.5		mA
			Outputs disabled		0.25		0.25		0.25		
	Control inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND		1.5			1.5		1.5		
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V	4							pF	
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V	10							pF	

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ This parameter is characterized, but not production tested.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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# SN54ABT657A, SN74ABT657A

## OCTAL TRANSCEIVERS WITH PARITY GENERATORS/CHECKERS AND 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ$ C			SN54ABT657A		SN74ABT657A		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A or B	B or A	1	3.2	4.2	1	5	1	4.6	ns
$t_{PHL}$			1	2.8	3.8	1	4.5	1	4.3	
$t_{PLH}$	A	PARITY	1.8	4.8	6.3	1.8	8.5	1.8	8.1	ns
$t_{PHL}$			2.3	4.9	6.4	2.3	8.1	2.3	7.7	
$t_{PLH}$	ODD/ $\overline{\text{EVEN}}$	PARITY, $\overline{\text{ERR}}$	1.1	3.3	4.2	1.1	5.3	1.1	4.9	ns
$t_{PHL}$			1.3	3.4	4.5	1.3	5.1	1.3	4.9	
$t_{PLH}$	B	$\overline{\text{ERR}}$	1.6	4.7	6.5	1.6	8.4	1.6	7.9	ns
$t_{PHL}$			2.1	4.9	6.9	2.1	8	2.1	7.8	
$t_{PLH}$	PARITY	$\overline{\text{ERR}}$	2	4.8	6.3	2	8.1	2	7.7	ns
$t_{PHL}$			2.1	4.9	6.7	2.1	8	2.1	7.5	
$t_{PZH}$	$\overline{\text{OE}}$	A, B, PARITY	1.4	4	5.4	1.4	6.8	1.4	6.5	ns
$t_{PZL}$			1.7	4.1	5.8	1.7	6.7	1.7	6.5	
$t_{PZH}$	$\overline{\text{OE}}$	$\overline{\text{ERR}}$	1.8	4.1	5.4	1.8	6.9	1.8	6.6	ns
$t_{PZL}$			3.3	6.2	7.6	3.3	9.7	3.3	9.2	
$t_{PHZ}$	$\overline{\text{OE}}$	A, B, PARITY, or $\overline{\text{ERR}}$	2.4	4.2	5.6	2.4	6.3	2.4	6.2	ns
$t_{PLZ}$			1.8	4.2	6.2	1.8	8.9	1.8	7.8	

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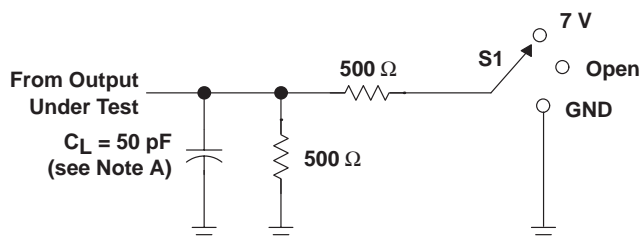


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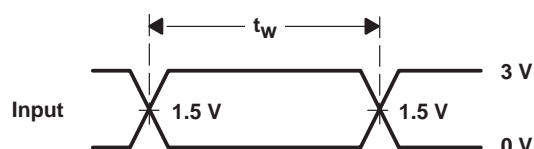
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## PARAMETER MEASUREMENT INFORMATION

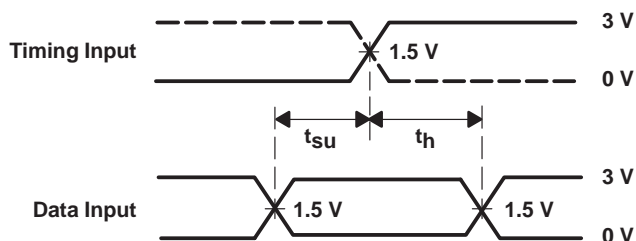


LOAD CIRCUIT

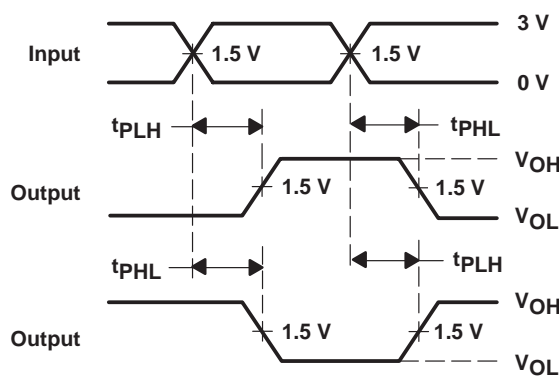
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



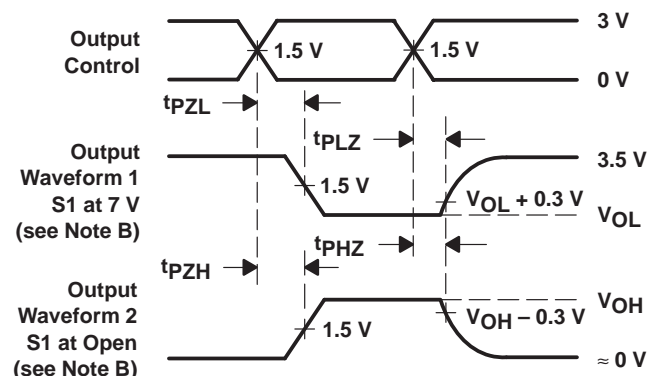
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.  
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN74ABT657ADBR</a>	Active	Production	SSOP (DB)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AB657A
SN74ABT657ADBR.B	Active	Production	SSOP (DB)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AB657A
<a href="#">SN74ABT657ADW</a>	Active	Production	SOIC (DW)   24	25   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT657A
SN74ABT657ADW.B	Active	Production	SOIC (DW)   24	25   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT657A

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT657ADBR	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT657ADBR	SSOP	DB	24	2000	353.0	353.0	32.0

## TUBE



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74ABT657ADW	DW	SOIC	24	25	506.98	12.7	4826	6.6
SN74ABT657ADW.B	DW	SOIC	24	25	506.98	12.7	4826	6.6

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